



**D20V0L1B2WS** 

#### LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Case Material: Molded Plastic, "Green" Molding Compound. UL

Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208

Flammability Classification Rating 94V-0

Weight: 0.004 grams (approximate)

Moisture Sensitivity: Level 1 per J-STD-020

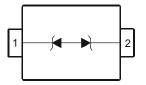
#### Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±30kV, Contact – ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used at Computer Interface Protection, Data Line and Power Line Protection
- PPAP Capable
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

SOD323



Top View

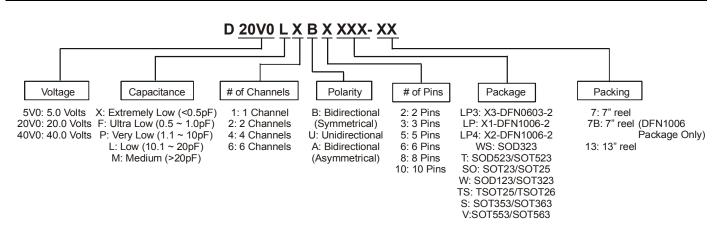


**Mechanical Data** 

Case: SOD323

Device Schematic

### Ordering Information (Note 4)



| Product        | Compliance | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|----------------|------------|---------|--------------------|-----------------|-------------------|
| D20V0L1B2WS-7  | AEC-Q101   | H/H     | 7                  | 8               | 3,000/Tape & Reel |
| D20V0L1B2WSQ-7 | Automotive | H/H     | 7                  | 8               | 3,000/Tape & Reel |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**

Notes:



H/H = Product Type Marking Code



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                     | Symbol                   | Value | Unit | Conditions             |
|------------------------------------|--------------------------|-------|------|------------------------|
| Peak Pulse Power Dissipation       | P <sub>PP</sub>          | 90    | W    | 8/20µs, Per Figure 2   |
| Peak Pulse Current                 | IPP                      | 3     | А    | 8/20µs, Per Figure 2   |
| ESD Protection – Contact Discharge | V <sub>ESD_Contact</sub> | ±30   | kV   | Standard IEC 61000-4-2 |
| ESD Protection – Air Discharge     | V <sub>ESD_Air</sub>     | ±30   | kV   | Standard IEC 61000-4-2 |

# **Thermal Characteristics**

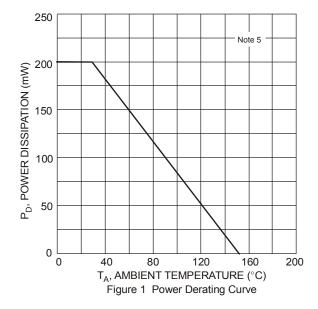
| Characteristic                                   | Symbol               | Value       | Unit |
|--------------------------------------------------|----------------------|-------------|------|
| Package Power Dissipation (Note 5)               | PD                   | 200         | mW   |
| Thermal Resistance, Junction to Ambient (Note 5) | R <sub>0JA</sub>     | 625         | °C/W |
| Operating and Storage Temperature Range          | TJ, T <sub>STG</sub> | -65 to +150 | °C   |

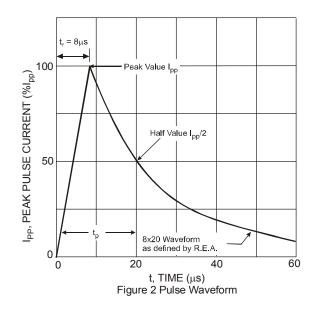
### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                        | Symbol           | Min | Тур | Max | Unit | Test Conditions                               |
|---------------------------------------|------------------|-----|-----|-----|------|-----------------------------------------------|
| Reverse Standoff Voltage              | V <sub>RWM</sub> | _   | —   | 20  | V    | —                                             |
| Channel Leakage Current (Note 6)      | I <sub>RM</sub>  | _   | —   | 100 | nA   | V <sub>RWM</sub> = 20V                        |
| Clamping Voltage, Positive Transients | V <sub>CL</sub>  | _   | —   | 27  | V    | I <sub>PP</sub> = 1A, t <sub>p</sub> = 8/20μS |
|                                       |                  | —   | —   | 30  | V    | I <sub>PP</sub> = 3A, t <sub>p</sub> = 8/20μS |
| Breakdown Voltage                     | V <sub>BR</sub>  | 21  | —   | 25  | V    | I <sub>R</sub> = 1mA                          |
| Differential Resistance               | R <sub>DIF</sub> | _   | 1.8 | —   | Ω    | I <sub>R</sub> = 1A, t <sub>p</sub> = 8/20µS  |
| Channel Input Capacitance             | CT               |     | 10  | 15  | pF   | $V_R = 0V$ , f = 1MHz                         |

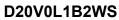
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

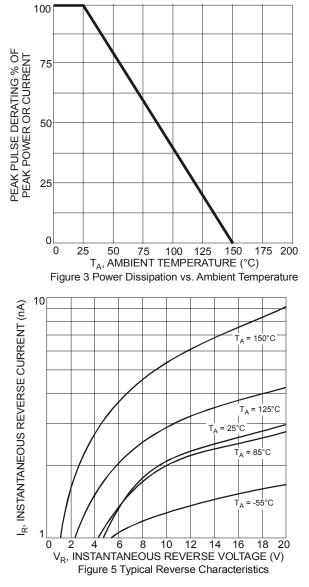
Short duration pulse test used to minimize self-heating effect.











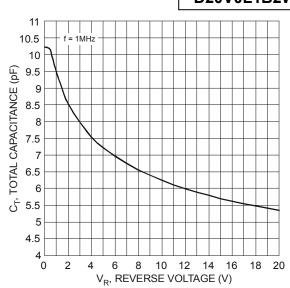
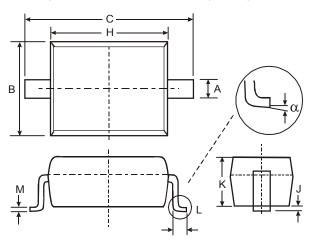


Figure 4 Typical Total Capacitance vs. Reverse Voltage

# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

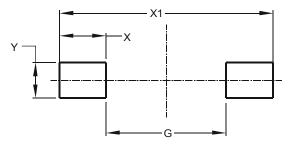


| SOD323               |      |      |  |
|----------------------|------|------|--|
| Dim                  | Min  | Max  |  |
| Α                    | 0.25 | 0.35 |  |
| В                    | 1.20 | 1.40 |  |
| C                    | 2.30 | 2.70 |  |
| Н                    | 1.60 | 1.80 |  |
| J                    | 0.00 | 0.10 |  |
| κ                    | 1.0  | 1.1  |  |
| L                    | 0.20 | 0.40 |  |
| М                    | 0.10 | 0.15 |  |
| α                    | 0°   | 8°   |  |
| All Dimensions in mm |      |      |  |



### Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| G          | 1.520         |
| Х          | 0.590         |
| X1         | 2.700         |
| Y          | 0.450         |

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